503973764 08/24/2016

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT4020420

		NEW ASSIGNMENT		
NATURE OF CONVEYANCE:		ASSIGNMENT		
CONVEYING PARTY DA	TA			
		Name	Execution Date	
DR. SURESH BABU PON	NAN		06/27/2016	
PADMANABAN VADIVEL	_		06/27/2016	
KUMARAN SETHURAMA	٩N		06/27/2016	
NAVEEN MURALIDHARA	۹N		06/27/2016	
RECEIVING PARTY DAT	Г А			
Name:	WIPRO	LIMITED		
Street Address:	DODDAKANNELLI, SARJAPUR ROAD			
City:	BANGALORE, KARNATAKA			
State/Country:	INDIA			
Postal Code:	560035			
PROPERTY NUMBERS	Total: 1	Number		
Property Type		Number		
Application Number:		15245223		
	sent to rovided 	<i>the e-mail address first; if that is unsu</i> <i>; if that is unsuccessful, it will be sent</i> kimberly.bailey@finnegan.com FINNEGAN HENDERSON 901 NEW YORK AVE WASHINGTON, D.C. 20001		
ATTORNEY DOCKET NUMBER:		11612.0389-00000		
NAME OF SUBMITTER:		KIMBERLY BAILEY		
SIGNATURE:		/kimberly bailey/		
DATE SIGNED:		08/24/2016		

ASSIGNMENT AND DECLARATION AND POWER OF ATTORNEY FOR UTILITY OR DESIGN PATENT APPLICATION

WHEREAS I/We, the below named inventor(s), (hereinafter referred to as Assignor(s)), have made an invention entitled:

METHOD AND SYSTEM FOR AUTOMATING EXECUTION OF PROCESSES

for which I/WE executed an application for United States Letters Patent concurrently herewith; and

WHEREAS, Wipro Limited a corporation of India

whose post office address is Doddakannelli, Sarjapur Road, Bangalore, Kamataka, India 560035

(hereinafter referred to as Assignee), is desirous of securing the entire right, title, and interest in and to this invention in all countries throughout the world, and in and to the application for United States Letters Patent on this invention and the Letters Patent to be issued upon this application;

NOW THEREFORE, be it known that, for good and valuable consideration the receipt of which from Assignee is hereby acknowledged, I/We, as Assignor(s), have sold, assigned, transferred, and set over, and do hereby sell, assign, transfer, and set over unto the Assignee, its lawful successors and assigns, my/our entire right, title, and interest in and to this invention and this application, and all divisions, and continuations thereof, and all Letters Patent of the United States which may be granted thereon, and all applications for Letters Patent which may hereafter be filed for this invention in any foreign country, and all applications for Letters Patent which may hereafter be filed for this invention in any foreign country and all Letters Patent which may be granted on this invention in any foreign country and all Letters Patent which may be granted on this invention in any foreign country, and reissues thereof; and I/We hereby authorize and request the Director of the United States Patent and Trademark Office and any official of any foreign country whose duty it is to issue patents on applications as described above, to issue all Letters Patent for this invention to Assignee, its successors and assigns, in accordance with the terms of this Assignment;

AND, IWE HEREBY covenant that IWe have the full right to convey the interest assigned by this Assignment, and IWe have not executed and will not execute any agreement in conflict with this Assignment,

AND, I/WE HEREBY further covenant and agree that I/We will, without further consideration, communicate with Assignee, its successors and assigns, any facts known to me/us respecting this invention, and testify in any legal proceeding, sign all lawful papers when called upon to do so, execute and deliver any and all papers that may be necessary or desirable to perfect the title to this invention in said Assignee, its successors or assigns, execute all divisional, continuation, and reissue applications, make all rightful oaths and generally do everything possible to aid Assignee, its successors and assigns, to obtain and enforce proper patent protection for this invention in the United States and any foreign country, it being understood that any expense incident to the execution of such papers shall be borne by the Assignee, its successors and assigns.

AND, I/WE HEREBY authorize and request that the attorneys having Power of Attorney in this application insert here in parentheses (Application No. <u>15/245,223</u>, filed <u>08/24/16</u>) the filing date and application number of said application when known.

As a named inventor below, I hereby declare that: (1) This declaration is directed to the above-identified application; (2) the above-identified application was made or authorized to be made by me; (3) my residence and mailing address are as stated below next to my name; and (4) I believe I am an original inventor or an original joint inventor of a claimed invention in the application. I hereby acknowledge that any willful false statements made in this declaration are punishable by fine or imprisonment of not more than five (5) years, or both, under section 1001 of Title 18 of the United States Code.

As a below named inventor, I have reviewed and understand the contents of the application, including the claims, and am aware of the duty to disclose to the US PTO all information known to me to be material to patentability as defined in 37C.F.R. § 1.56.

Page 1 of 3

PATENT REEL: 039514 FRAME: 0797 I hereby appoint the patent practitioners associated with FINNEGAN, HENDERSON, FARABOW, GARRETT & DUNNER, L.L.P., CUSTOMER NUMBER 121,627 to prosecute this application and transact all business in the Patent and Trademark Office connected therewith.

Authorization To Permit Access To Application by Participating Offices:

If checked, the undersigned hereby grants the USPTO authority to provide the European Patent Office (EPO), the Japan Patent Office (JPO), the Korean Intellectual Property Office (KIPO), the World Intellectual Property Office (WIPO), and any other intellectual property offices in which a foreign application claiming priority to the above-identified patent application is filed access to the above-'KIPO, WIPO, or other intellectual property office in which a foreign application claiming priority to the above-identified patent application is filed to have access to the above-identified patent application. See 37 CFR 1.14(c) and (h). This box should not be checked if the Applicant does not wish the EPO, JPO, KIPO, or other intellectual property office in which a foreign application claiming priority to the above-identified application is filed to have access to the above-identified patent application is filed to have access to the above-identified patent application is filed to have access to the above-identified patent application is filed to have access to the above-identified patent application is filed to have access to the above-identified patent application is filed to have access to the above-identified patent application is filed to have access to the above-identified patent application is filed to have access to the above-identified patent application is filed to have access to the above-identified patent application is filed to have access to the above-identified patent application.

in accordance with 37 CFR 1.14(h)(3), access will be provided to a copy of the above-identified patent application with respect to: 1) the aboveidentified patent application-as-filed; 2) any foreign application to which the above-identified patent application claims priority under 35 U.S.C. 119(a)-(d) if a copy of the foreign application that satisfies the certified copy requirement of 37 CFR 1.55 has been filed in the above-identified patent application; and 3) any U.S. epplication-as-filed from which benefit is sought in the above-identified patent application.

In accordance with 37 CFR 1.14(c), access may be provided to information concerning the date of filing the Authorization to Permit Access to Application by Participating Offices.

1. FULL NAME OF SOLE OR FIRST ASSIGNOR	ASSIGNOR'S SIGNATURE	DATE			
Dr. SURESH BABU PONNAN	-TZ-	27 ^H JUNE 2016			
MAILING ADDRESS	<u>.</u>	RESIDENCE			
No.24 & 25, 8th Cross Street, Heritage Jayendar Nagar, Sembakkam, Tambaram, 600073					
2. FULL NAME OF SOLE OR FIRST ASSIGNOR PADMANABAN VADIVEL	ASSIGNOR'S SIGNATURE V. Paramanana	27 th Jun 2016			
MAILING ADDRESS		RESIDENCE			
Flat #4, Plot #8, Sarvamangala Homes, G D	INDIA '				
Selaiyur , Chennai 600073					
3. FULL NAME OF SOLE OR FIRST ASSIGNOR	ASSIGNOR'S SIGNATURE	DATE			
KUMARAN SETHURAMAN	S. Vienne	27 ^H Jun 2016			
MAILING ADDRESS		RESIDENCE			
141, Ponnusamy Nagar, Mariyamman koil	INDIA				

IN TESTIMONY WHEREOF, I/We have hereunto set our hands.

SOLE/JOINT INVENTION (Worldwide Rights) Attorney Docket No.

4. FULL NAME OF SOLE OR FIRST ASSIGNOR	ASSIGNOR'S SIGNATURE	DATE
NAVEEN MURALIDHARAN	Nhun mp.	27.6.16
MAILING ADDRESS	RESIDENCE	
No.313, S.P.H. Road, Melnallathur post, T	INDIA	

Page 3 of 3

. **.** .

.

RECORDED: 08/24/2016